

**SUPPLEMENTAL RESPONSE UNDER 37 C.F.R. § 1.111(a)(2)
EXAMINING GROUP 1765**

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of	: K.R. Udayakumar et al.	Confirmation No.:	8320
Application Number	: 10/721,932		
Filed	: November 25, 2003		
Title	: METHOD FOR ETCHING A SUBSTRATE AND A DEVICE FORMED USING THE METHOD		
TC/Art Unit	: 1765		
Examiner:	: Lan VINH		
Docket No.	: T1-35507 (0025.0203)		
Customer No.	: 23494		

MAIL STOP AMENDMENT
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

SUPPLEMENTAL AMENDMENT

Pursuant to an Interview which took place with the Examiner on January 3, 2008, and pursuant to the provisions of 37 C.F.R. 1.111(a)(2), the following Supplemental Amendments and Remarks are provided at the request of the Examiner and to place the application into condition for allowance. Please further amend the application as follows:

Current Claims are reflected in the listing of claims in this paper beginning at page 2.

Remarks begin at page 7.